

SANYO

No. 4988A

LC74781, 74781M

On-Screen Display Controller LSI for VCR Products

Overview

The LC74781 and LC74781M are on-screen display CMOS LSIs that display characters and patterns on a TV screen under microprocessor control. The LC74781 and LC74781M display up to 12 lines of 24 characters, each in a 12×18 dot matrix.

Features

- Display structure: 12 lines \times 24 characters (up to 288 characters)
- Character structure: 12 (horizontal) \times 18 (vertical) dots
- Character sizes: Three size settings each in the vertical and horizontal directions
- Character set: 128 characters
- Display start position: 64 position settings each in the vertical and horizontal directions
- Blinking: In individual character units
- Blinking types: Two types with periods of about 0.5 and 1.0 second
- Blanking: Whole font area blanking (12×18 dots)
- Background colors: 8 colors (in internal synchronization mode): 4fSC (NTSC/PAL/PAL-M/PAL-N)

Background colors: 4 colors (in internal synchronization mode): 2fSC (NTSC)

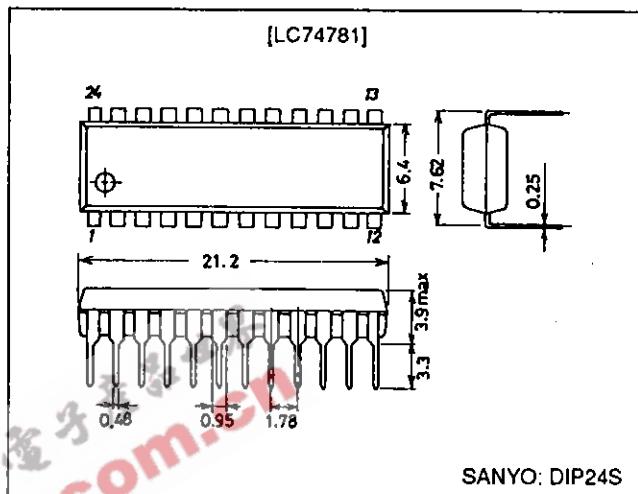
Background colors: 1 color (blue) (in internal synchronization mode): 2fSC (PAL/PAL-M/PAL-N)

- External control input: 8-bit serial input format
- Built-in sync separator circuit
- Character blanked data output
- Video output: Compound NTSC, PAL, PAL-N and PAL-M output

Package Dimensions

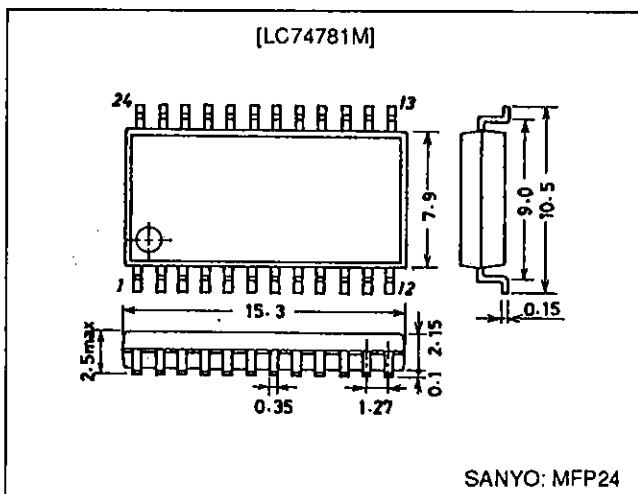
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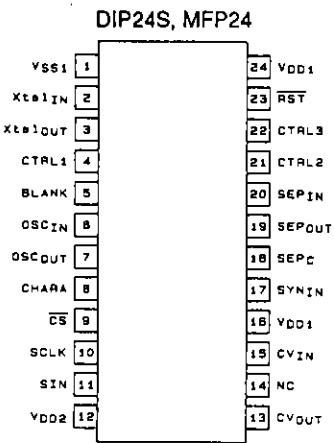
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3045B-MFP24



Pin Functions

Pin No.	Symbol	Function	Description
1	V _{SS1}	Ground	Ground connection (digital system ground)
2	Xtal _{IN}	Crystal oscillator connection	Used to connect the crystal oscillator and capacitor used to generate the internal synchronization signal, or to input an external clock (2fsc or 4fsc).
3	Xtal _{OUT}		
4	CTRL1	Crystal oscillator input switching	Switches between external clock input mode and crystal oscillator mode. Low = crystal oscillator mode, high = external clock mode
5	BLANK	Blanking output	Outputs the blank signal (the OR of the character and border signals). (Outputs a composite sync signal when MOD0 is high.) Outputs the crystal oscillator clock during reset (when the RST pin is low), but can be set up to not output this signal by microprocessor command.
6	OSC _{IN}	LC oscillator connection	Connections for the coil and capacitor that form the oscillator that generates the character output dot clock.
7	OSC _{OUT}		
8	CHARA	Character output	Outputs the character signal. (Functions as the external synchronization signal discrimination signal output pin when MOD0 is high, and outputs the state of the judgment as to whether the external synchronization signal is present or not. Outputs a high level when the synchronization signal is present.) Outputs the dot clock (LC oscillator) during reset, but can be set up to not output this signal by microprocessor command.
9	CS	Enable input	Serial data input enable input. Serial data input is enabled when low. A pull-up resistor is built in (hysteresis input).
10	SCLK	Clock input	Serial data input clock input. A pull-up resistor is built in (hysteresis input).
11	SIN	Data input	Serial data input. A pull-up resistor is built in (hysteresis input).
12	V _{DD2}	Power supply	Composite video signal level adjustment power supply pin (analog system power supply).
13	CV _{OUT}	Video signal output	Composite video signal output
14	NC		Must be either connected to ground or left open.
15	CV _{IN}	Video signal input	Composite video signal input
16	V _{DD1}	Power supply	Power supply (+5 V: digital system power supply)
17	SYN _{IN}	Sync separator circuit input	Video signal input for the built-in sync separator circuit (Used for either horizontal synchronization signal or composite sync signal input when the built-in sync separator circuit is not used.)
18	SEP _C	Sync separator circuit bias voltage	Built-in sync separator circuit bias voltage monitor pin
19	SEP _{OUT}	Composite sync signal output	Built-in sync separator circuit composite sync signal output. (When MOD1 is high, outputs a high level during internal synchronization and a low level during external synchronization.) (Outputs the SYN _{IN} input signal when the internal sync separator circuit is not used.)
20	SEP _{IN}	Vertical synchronization signal input	Inputs a vertical synchronization signal created by integrating the SEP _{OUT} pin output signal. An integrator must be attached at the SEP _{OUT} pin. This pin must be tied to V _{DD1} if unused.
21	CTRL2	NTSC/PAL-M switching input	The setting indicated by this pin takes priority in switching between the NTSC, PAL, PAL-M and PAL-N formats. A low level selects NTSC after a reset. The microprocessor command NTSC, PAL, PAL-M, or PAL-N setting is valid. High = PAL-M format.
22	CTRL3	SEP _{IN} input control	Controls whether or not the VSYNC signal is input to the SEP _{IN} input. Low = VSYNC input, high = VSYNC not input.
23	RST	Reset input	System reset input. A pull-up resistor is built in (hysteresis input).
24	V _{DD1}	Power supply (+5 V)	Power supply (+5 V: digital system power supply)

Pin Assignment

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Top view

Specifications**Absolute Maximum Ratings at Ta = 25°C**

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V _{DD} max	V _{DD} 1 and V _{DD} 2 pins	V _{SS} - 0.3 to V _{SS} + 7.0	V
Maximum input voltage	V _{IN} max	All pins	V _{SS} - 0.3 to V _{DD} + 0.3	V
Maximum output voltage	V _{OUT} max	BLANK, CHARA and SEP _{OUT} pins	V _{SS} - 0.3 to V _{DD} + 0.3	V
Allowable power dissipation	P _d max	T _a = 25°C	350	mW
Operating temperature	T _{opr}		-30 to +70	°C
Storage temperature	T _{stg}		-40 to +125	°C

Allowable Operating Ranges at Ta = -30 to +70°C

Parameter	Symbol	Conditions	min	typ	max	Unit
Supply voltage	V _{DD1}	V _{DD} 1 pin	4.5	5.0	5.5	V
	V _{DD2}	V _{DD} 2 pin	4.5	5.0	1.27 V _{DD1}	V
Input high level voltage	V _{IH1}	RST, CS, SIN and SCLK pins	0.8 V _{DD1}		V _{DD1} + 0.3	V
	V _{IH2}	CTRL1, CTRL2, CTRL3 and SEP _{IN} pins	0.7 V _{DD1}		V _{DD1} + 0.3	V
Input low level voltage	V _{IL1}	RST, CS, SIN and SCLK pins	V _{SS} - 0.3		0.2 V _{DD1}	V
	V _{IL2}	CTRL1, CTRL2, CTRL3 and SEP _{IN} pins	V _{SS} - 0.3		0.3 V _{DD1}	V
Pull-up resistance	R _{PU}	RST, CS, SIN and SCLK pins, applies to pins set by options.	25	50	90	kΩ
Composite video input voltage	V _{IN1}	CV _{IN} pin: V _{DD1} = 5 V		2.0		V _{p-p}
	V _{IN2}	SYN _{IN} pin: V _{DD1} = 5 V		2.0	2.5	V _{p-p}
Input voltage	V _{IN3}	Xtal _{IN} pin (in external clock input mode), f _{in} = 2fsc or 4fsc: V _{DD1} = 5 V	0.10		5.0	V _{p-p}
Oscillator frequency	Fosc1	Xtal _{IN} and Xtal _{OUT} oscillator pins (2fsc: NTSC)		7.159		MHz
	Fosc1	Xtal _{IN} and Xtal _{OUT} oscillator pins (4fsc: NTSC)		14.318		MHz
	Fosc1	Xtal _{IN} and Xtal _{OUT} oscillator pins (2fsc: PAL)		8.867		MHz
	Fosc1	Xtal _{IN} and Xtal _{OUT} oscillator pins (4fsc: PAL)		17.734		MHz
	Fosc1	Xtal _{IN} and Xtal _{OUT} oscillator pins (2fsc: PAL-M)		7.151		MHz
	Fosc1	Xtal _{IN} and Xtal _{OUT} oscillator pins (4fsc: PAL-M)		14.302		MHz
	Fosc1	Xtal _{IN} and Xtal _{OUT} oscillator pins (2fsc: PAL-N)		7.164		MHz
	Fosc1	Xtal _{IN} and Xtal _{OUT} oscillator pins (4fsc: PAL-N)		14.328		MHz
	Fosc2	OSC _{IN} and OSC _{OUT} oscillator pins (LC oscillator)	5		10	MHz

Note: If the Xtal_{IN} pin is used in clock input mode, be sure to prevent input noise from becoming a problem.

Electrical Characteristics at $T_a = -30$ to $+70^\circ\text{C}$, $V_{DD1} = 5 \text{ V}$ unless otherwise specified

Parameter	Symbol	Conditions			min	typ	max	Unit
Input off leakage current	I_{leak1}	CV_{IN} pin					1	μA
Output off leakage current	I_{leak2}	CV_{OUT} pin					1	μA
Output high level voltage	V_{OH1}	BLANK, CHARA and SEP_{OUT} pins: $V_{DD1} = 4.5 \text{ V}$, $I_{OH} = -1.0 \text{ mA}$			3.5			V
Output low level voltage	V_{OL1}	BLANK, CHARA and SEP_{OUT} pins: $V_{DD1} = 4.5 \text{ V}$, $I_{OH} = 1.0 \text{ mA}$					1.0	V
Input current	I_{IH}	RST, CS, SIN, SCLK, CTRL1, CTRL3 and SEP_{IN} pins: $V_{IN} = V_{DD1}$					1	μA
	I_{IL}	CTRL1, CTRL2, CTRL3 and OSC_{IN} pins: $V_{IN} = V_{SS1}$			-1			μA
Operating current drain	I_{DD1}	V_{DD1} pin; all outputs: open, Xtal: 7.159 MHz, LC: 8 MHz					15	mA
	I_{DD2}	V_{DD2} pin: $V_{DD2} = 5 \text{ V}$					20	mA
Sync level	V_{SN}	CV_{OUT} pin	$V_{DD1} = 5.0 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$	*1	0.70	0.82	0.94	V
				*2	0.91	1.03	1.15	V
Pedestal level	V_{PD}	CV_{OUT} pin	$V_{DD1} = 5.0 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$	*1	1.31	1.43	1.55	V
				*2	1.53	1.65	1.77	V
Color burst low level	V_{CBL}	CV_{OUT} pin	$V_{DD1} = 5.0 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$	*1	1.00	1.12	1.24	V
				*2	1.21	1.33	1.45	V
Color burst high level	V_{CBH}	CV_{OUT} pin	$V_{DD1} = 5.0 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$	*1	1.63	1.75	1.87	V
				*2	1.84	1.96	2.08	V
Background color low level	V_{RSL}	CV_{OUT} pin	$V_{DD1} = 5.0 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$	*1	1.47	1.59	1.71	V
				*2	1.68	1.80	1.92	V
Background color high level	V_{RSH}	CV_{OUT} pin	$V_{DD1} = 5.0 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$	*1	1.99	2.11	2.23	V
				*2	2.19	2.31	2.43	V
Border level 0	V_{BK0}	CV_{OUT} pin	$V_{DD1} = 5.0 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$	*1	1.42	1.54	1.66	V
				*2	1.63	1.75	1.87	V
Border level 1	V_{BK1}	CV_{OUT} pin	$V_{DD1} = 5.0 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$	*1	1.99	2.11	2.23	V
				*2	2.19	2.31	2.43	V
Character level	V_{CHA}	CV_{OUT} pin	$V_{DD1} = 5.0 \text{ V}$, $V_{DD2} = 5.0 \text{ V}$	*1	2.58	2.70	2.82	V
				*2	2.78	2.90	3.02	V

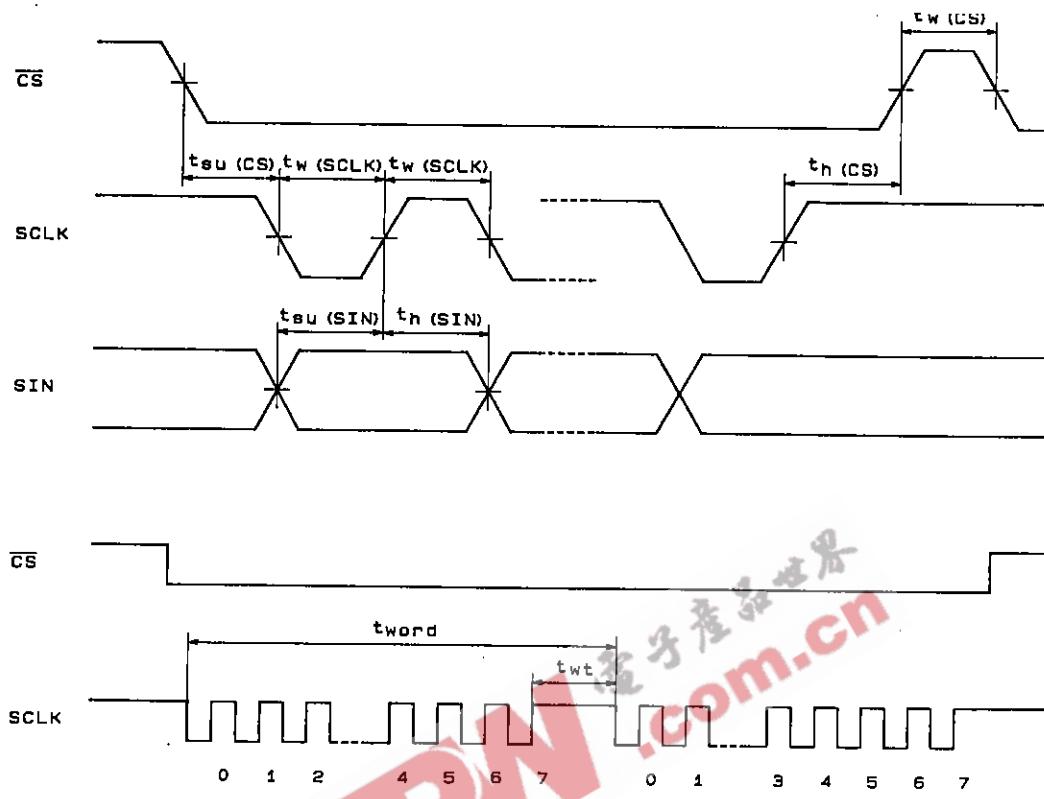
Note: 1. When the sync level is 0.8 V.

2. When the sync level is 1.0 V.

Timing Characteristics at $T_a = -30$ to $+70^\circ\text{C}$, $V_{DD1} = 5 \pm 0.5 \text{ V}$

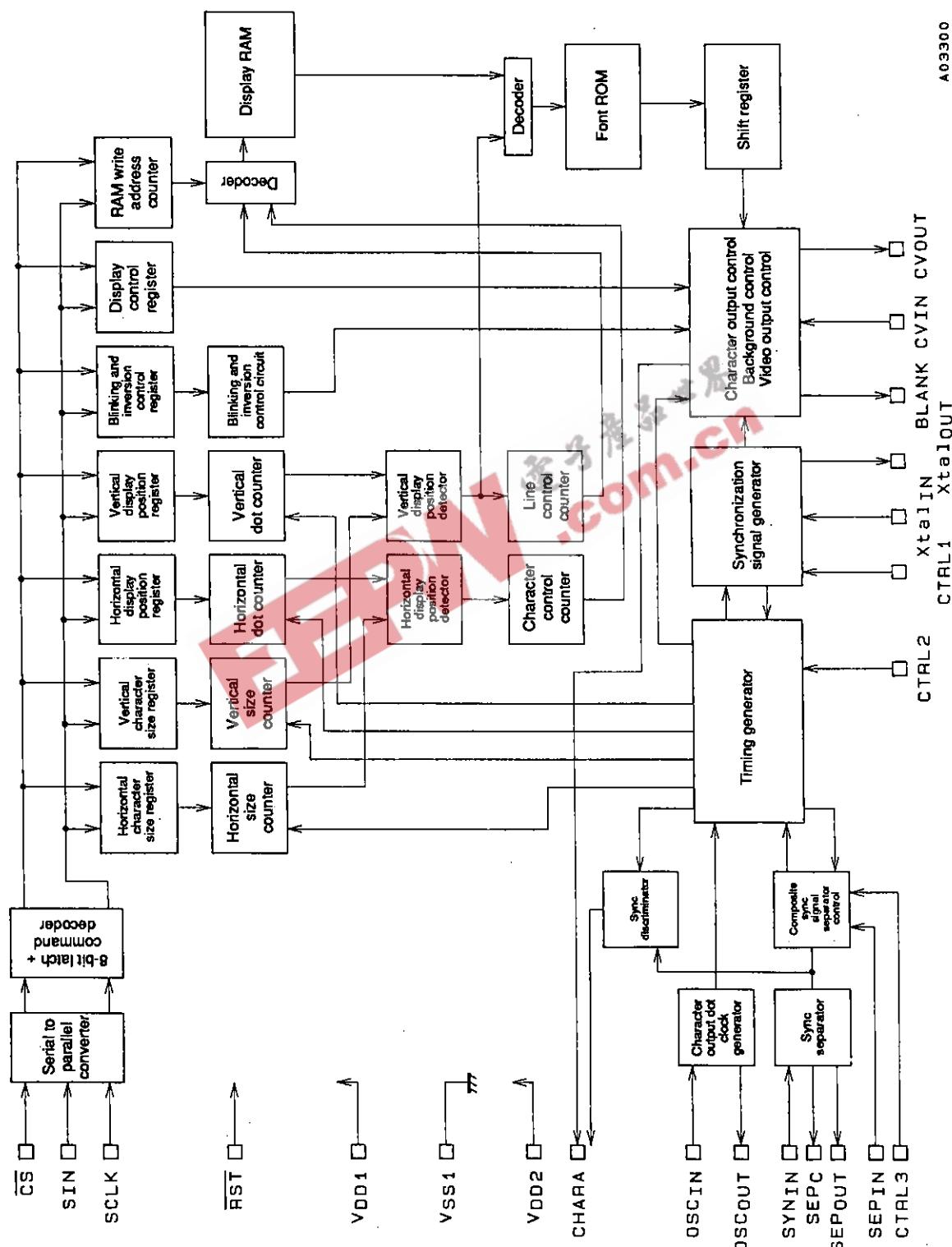
Parameter	Symbol	Conditions			min	typ	max	Unit
Minimum input pulse width	$t_W(\text{SCLK})$	$SCLK$ pin			200			ns
	$t_W(\text{CS})$	\overline{CS} pin (the period when \overline{CS} is high)			1			μs
Data setup time	$t_{SU}(\text{CS})$	\overline{CS} pin			200			ns
	$t_{SU}(\text{SIN})$	SIN pin			200			ns
Data hold time	$t_h(\text{CS})$	\overline{CS} pin			2			μs
	$t_h(\text{SIN})$	SIN pin			200			ns
One word write time	t_{word}	8-bit data write time			4.2			μs
	t_{wt}	RAM data write time			1			μs

Serial Data Input Timing



A03299

System Block Diagram



A03300

CTRL1 CTRL2

XTALIN XTALOUT

BLANK CVIN CVOUT

Display Control Commands

The display control commands have a serial input format with 8-bit units. A command consists of a command identifier code in the first byte and data in the second and subsequent bytes. There are eight commands as listed below.

- ① COMMAND0: Display memory (VRAM) write address setup command
- ② COMMAND1: Display character data write command
- ③ COMMAND2: Vertical display start position and vertical character size setup command
- ④ COMMAND3: Horizontal display start position and horizontal character size setup command
- ⑤ COMMAND4: Display control setup command
- ⑥ COMMAND5: Display control setup command
- ⑦ COMMAND6: Synchronization signal detection setup command
- ⑧ COMMAND7: Display control setup command

Display Control Command Table

Command	First byte					Second byte													
	Command identification code				Data					Data									
	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0			
COMMAND0 (Set write address)	1	0	0	0	V3	V2	V1	V0	0	0	0	H4	H3	H2	H1	H0			
COMMAND1 (Write character)	1	0	0	1	0	0	0	at	0	c6	c5	c4	c3	c2	c1	c0			
COMMAND2 (Set vertical display start position and vertical character size)	1	0	1	0	VS 21	VS 20	VS 11	VS 10	0	FS	VP 5	VP 4	VP 3	VP 2	VP 1	VP 0			
COMMAND3 (Set horizontal display start position and horizontal character size)	1	0	1	1	HS 21	HS 20	HS 11	HS 10	0	LC	HP 5	HP 4	HP 3	HP 2	HP 1	HP 0			
COMMAND4 (Display control)	1	1	0	0	TST MOD	RAM ERS	OSC STP	SYS RST	0	BLK 2	BLK 1	BLK 0	BK 1	BK 0	RV 0	DSP ON			
COMMAND5 (Display control)	1	1	0	1	NP 1	NP 0	NON	INT	0	0	0	BCL	CB	PH 2	PH 1	PH 0			
COMMAND6 (Synchronization signal detection)	1	1	1	0	MOD 1	MOD 0	DIS LIN	MUT	0	RN 2	RN 1	RN 0	SN 3	SN 2	SN 1	SN 0			
COMMAND7 (Display control)	1	1	1	1	EX 1	PD 1	EX 0	PD 0	0	0	0	VNP SEL	VSP SEL	MSK ERS	MSK SEL	EGL SEL			

Once written, the command identifier code in the first byte is stored until the next first byte is written. However, when the display character data write command (COMMAND1) is written, the LC74781/M locks into the display character data write mode, and another first byte cannot be written.

When a high level is input to the CS pin, the LC74781/M is set to COMMAND0 (display memory write address setup mode).

① COMMAND0 (Display memory write address setup command)

First byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	1	Command 0 identification code Set the display memory write address.	
6	—	0		
5	—	0		
4	—	0		
3	V3	0		
		1		
2	V2	0		
		1		
1	V1	0	Display memory address (0 to B hexadecimal)	
		1		
0	V0	0		
		1		

Second byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	0	Second byte identification bit	
6	—	0		
5	—	0		
4	H4	0		
		1		
3	H3	0		
		1		
2	H2	0		
		1	Display memory address (0 to 17 hexadecimal)	
1	H1	0		
		1		
0	H0	0		
		1		

Note: The register states are all set to zero when the LC74781/M is reset with the RST pin.

② COMMAND1 (Display character data write setup command)

First byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	1	Command 1 identification code Set up display character data write.	When this command is input, the LC74781/M locks into the display character data write mode until the CS pin goes high.
6	—	0		
5	—	0		
4	—	1		
3	—	0		
2	—	0		
1	—	0		
0	at	0	Character attribute off	
		1	Character attribute on	

Second byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	0		
6	c6	0		
		1		
5	c5	0		
		1		
4	c4	0		
		1		
3	c3	0		
		1		
2	c2	0		
		1		
1	c1	0		
		1		
0	c0	0		
		1		

Note: The register states are all set to zero when the LC74781/M is reset with the RST pin.

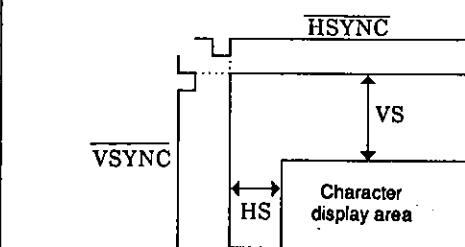
③ COMMAND2 (Vertical display start position and vertical character size setup command)

First byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	1		
6	—	0		
5	—	1		
4	—	0		
3	VS21	0		
		1	VS21 VS20 0 1 0 1H per dot 2H per dot 1 3H per dot 1H per dot	
2	VS20	0		
		1		
1	VS11	0	VS11 VS10 0 1 0 1H per dot 2H per dot	
		1	1 3H per dot 1H per dot	
0	VS10	0		
		1		

Second byte

DA0 to DA7	Register name	Register content		Note
		State	Function	
7	—	0	Second byte identification bit	
6	FS	0	Crystal oscillator frequency: 2fsc	
		1	Crystal oscillator frequency: 4fsc	
5	VP5 (MSB)	0	If VS is the vertical display start position then: $VS = H \times \sum_{n=0}^5 2^n VP_n$	
		1		
4	VP4	0		
		1	H: the horizontal synchronization pulse period	
3	VP3	0		
		1		
2	VP2	0		
		1		
1	VP1	0		
		1		
0	VP0 (LSB)	0		
		1		



The vertical display start position is set by the 6 bits VP0 to VP5.
The weight of bit 1 is 2H.

Note: The register states are all set to zero when the LC74781/M is reset with the RST pin.

④ COMMAND3 (Horizontal display start position and horizontal character size setup command)

First byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	1	Command 3 identification code				
6	—	0	Set the horizontal display start position and horizontal character size.				
5	—	1					
4	—	1					
3	HS21	0	HS21	HS20	0	1	
		1			0	1 Tc per dot	
2	HS20	0			1	2 Tc per dot	
		1			0	3 Tc per dot	
1	HS11	0		HS11	0	1	
		1			0	1 Tc per dot	
0	HS10	0			1	2 Tc per dot	
		1			0	3 Tc per dot	
		1			1	1 Tc per dot	

Second byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	0	Second byte identification bit				
6	LC	0	An LC oscillator is used for the dot clock.				
		1	A crystal oscillator is used for the dot clock.				
5	HP5 (MSB)	0	If HS is the horizontal start position then:				
		1	$HS = Tc \times (2 \sum_{n=0}^5 2^n HP_n)$				
4	HP4	0	Tc: Period of the oscillator connected to OSCIN/OSCOUP in operating mode.				
		1					
3	HP3	0					
		1					
2	HP2	0					
		1					
1	HP1	0					
		1					
0	HP0 (LSB)	0					
		1					

Note: The register states are all set to zero when the LC74781/M is reset with the RST pin.

⑤ COMMAND4 (Display control setup command)

First byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	1					
6	—	1	Command 4 identification code				
5	—	0	Display control				
4	—	0					
3	TSTMOD	0	Normal operating mode				
		1	Test mode				
2	RAMERS	0					
		1	Erase display RAM (set to 7F hexadecimal)				
1	OSCSTP	0	Do not stop the crystal oscillator and LC oscillator circuits.				
		1	Stop the crystal oscillator and LC oscillator circuits.				
0	SYSRST	0					
		1	Reset all registers and turn the display off.				

Second byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	0	Second byte identification bit				
6	BLK2	0	Character display block			Full character size specification	
		1	Video display block				
5	BLK1	0	BLK1	BLK0	0	1	Changes the blanking size.
		1		0	Blanking off	Character size	
4	BLK0	0		1	Border size	Full character size	
		1					
3	BK1	0	Blinking period: about 0.5 s				Switches the blinking period.
		1	Blinking period: about 1.0 s				
2	BK0	0	Blinking off				When blinking is specified for reversed characters, the blinking will be between normal character and reversed character display.
		1	Blinking on				
1	RV	0	Reverse (character reversing) off				
		1	Reverse (character reversing) on				
0	DSPON	0	Character display off				
		1	Character display on				

Note: The register states are all set to zero when the LC74781/M is reset with the RST pin.

⑥ COMMAND5 (Display control setup command)

First byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	1	Command 5 identification code Display control				
6	—	1					
5	—	0					
4	—	1					
3	NP1	0	NP1	NP0	0	1	Switches between NTSC, PAL, PAL-M and PAL-N
		1		0	NTSC	PAL-M	
2	NP0	0		1	PAL	PAL-N	
		1					
1	NON	0	Interlaced				Switches between interlaced and non-interlaced displays
		1	Non-interlaced				
0	INT	0	External synchronization				Switches between external and internal synchronization
		1	Internal synchronization				

Second byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	0	Second byte identification bit				
6	—	0					
5	—	0					
4	BCL	0	Background color present				
		1	No background color (only the background level is set)				
3	CB	0	Outputs a color burst signal.				
		1	Stops color burst signal output.				
2	PH2	0	Phase 2	Phase 1	Phase 0	Background color (phase)	
		1					
1	PH1	0	0	0	0	NTSC PAL	
		1	0	0	1	In phase* In phase	
0	PH0	0	0	1	0	3π/2* ±π/2	
		1	0	1	1	π* ±π	
		0	1	0	0	3π/4 ±3π/4	
		1	1	0	1	π/4 ±π/4	
		0	1	1	0	7π/4 ±π/4	
		1	1	1	1	5π/4 ±3π/4	

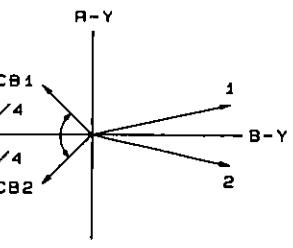
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Note: The register states are all set to zero when the LC74781/M is reset with the RST pin.

⑦ COMMAND6 (Synchronization signal detection setup command)

First byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	1					
6	—	1	Command 6 identification code				
5	—	1	Synchronization signal control settings				
4	—	0					
3	MOD1	0	Sync separator circuit signal				
		1	High level output during internal synchronization				
2	MODO	0	Pin 5: Blank signal Pin 8: Character signal				
		1	Pin 5: Composite synchronization signal Pin 8: External synchronization signal discrimination output signal				
1	DISLIN	0	12 lines				
		1	10 lines				
0	MUT	0	Normal output				
		1	CV _{IN} is cut and CV _{OUT} is fixed at the pedestal level.				



*: When 2fsc NTSC is used A03301

Second byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	0	Second byte identification bit				
6	RN2	0	RN2 RN1 RN0 Number of times HSYNC detected				
		1	0 0 0	0 times			
5	RN1	0	0 0 1	4 times			
		1	0 1 0	8 times			
4	RN0	0	1 0 0	16 times			
		1					
3	SN3	0	SN3 SN2 SN1 SN0 Number of times HSYNC detected				
		1	0 0 0 0	Not detected			
2	SN2	0	0 0 0 1	32 times			
		1	0 0 1 0	64 times			
1	SN1	0	0 1 0 0	128 times			
		1	1 0 0 0	256 times			
0	SN0	0					
		1					

Note: The register states are all set to zero when the LC74781/M is reset with the RST pin.

⑧ COMMAND7 (Display control setup command)

First byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	1	Command 7 identification code Display control setup				
6	—	1					
5	—	1					
4	—	1					
3	EX1	0	MODE1 setting output				
		1	PORT DATA1 setting output				
2	PD1	0	The output is set low.				
		1	The output is set high.				
1	EX0	0	MODE0 setting output				
		1	PORT DATA0 setting output				
0	PD0	0	The output is set low.				
		1	The output is set high.				

Second byte

DA0 to DA7	Register name	Register content				Note	
		State	Function				
7	—	0	Second byte identification bit				
6	—	0					
5	—	0					
4	VNPSEL	0	V falling edge detection				
		1	V rising edge detection				
3	VSPSEL	0	VSEP: about 8.9 µs (for NTSC)				
		1	VSEP: about 17.8 µs (for NTSC)				
2	MSKERS	0	Mask valid				
		1	Mask invalid				
1	MSKSEL	0	3H (for NTSC)				
		1	20H (for NTSC)				
0	EGL	0	Border level 0 only (VBK0)				
		1	Border level has two stages (VBK0, VBK1)				

Note: The register states are all set to zero when the LC74781/M is reset with the RST pin.

Display Screen Structure

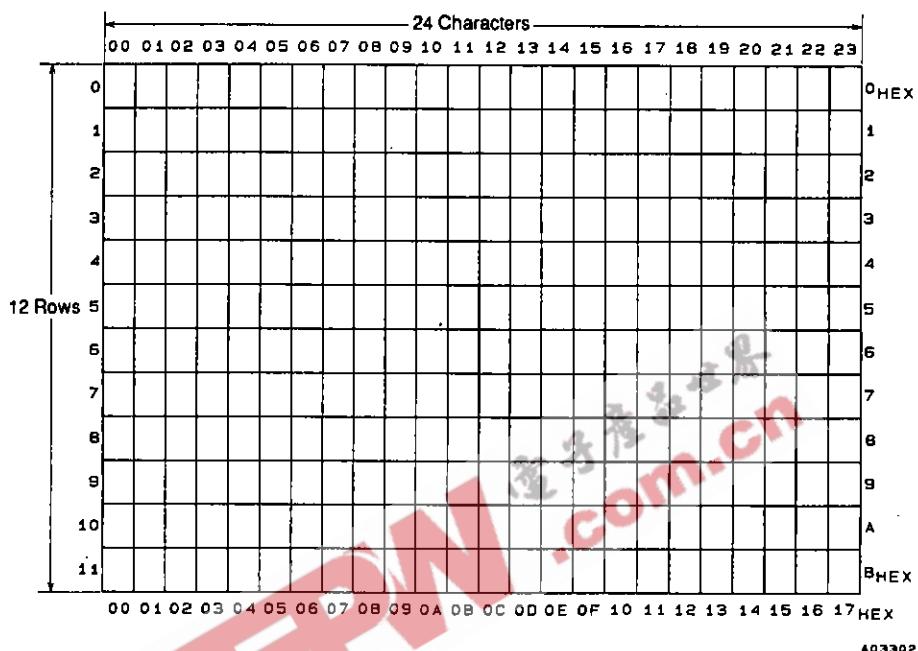
The display consists of 24 characters × 12 rows.

The maximum number of displayed character is 288.

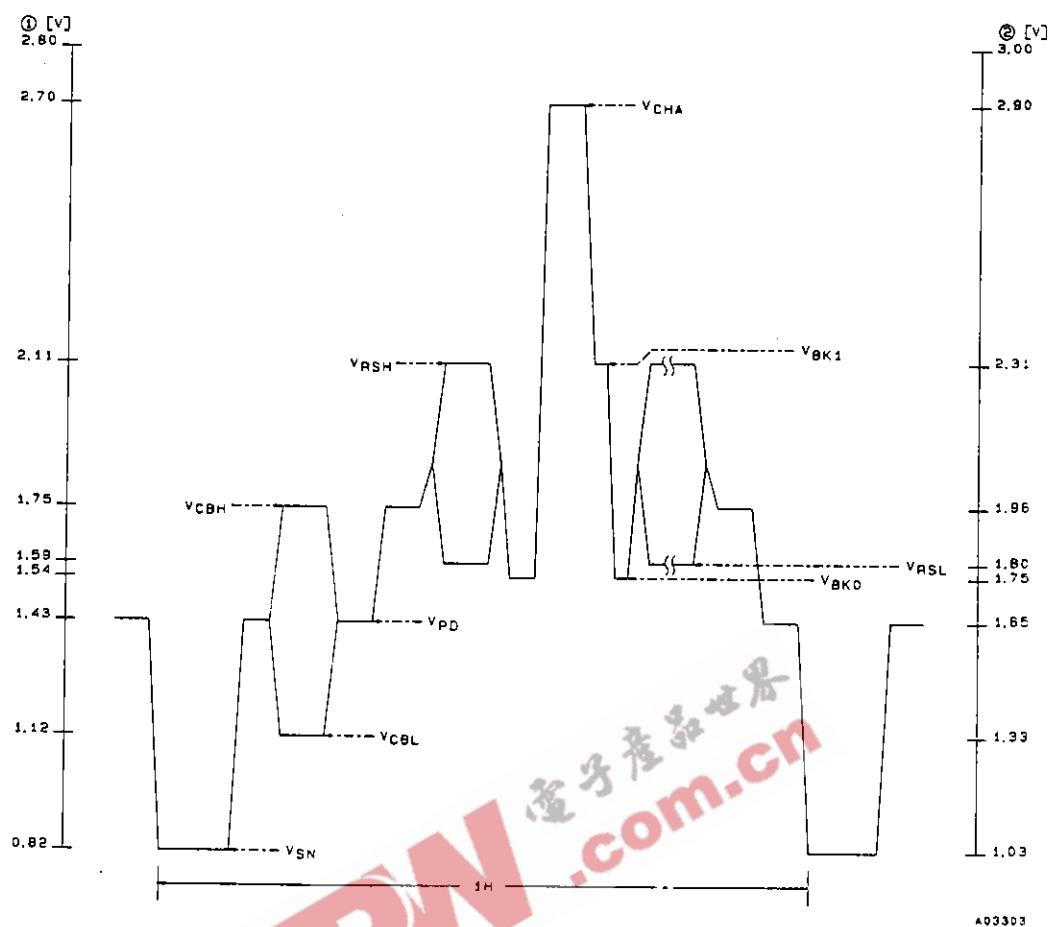
The maximum number of characters is reduced to less than 288 when the character size is enlarged.

Display memory addresses are specified as row (0 to 11 decimal) and column (0 to 23 decimal) addresses.

Display Screen Structure (display memory addresses)



Composite Video Signal Output Level (internally generated level)

CV_{OUT} output level waveform ($V_{DD2} = 5.00$ V)

Output level	Output voltage ① [V]	Output voltage ② [V]
V_{CHA} : Character	2.70	2.90
V_{BK1} : Border	2.11	2.31
V_{RSH} : Background color high	2.11	2.31
V_{CBH} : Color burst high	1.75	1.96
V_{RSL} : Background color low	1.59	1.80
V_{BK0} : Border	1.54	1.75
V_{PD} : Pedestal	1.43	1.65
V_{CBL} : Color burst low	1.12	1.33
V_{SN} : Sync	0.82	1.03

 $V_{DD2} = 5.00$ V

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